GL10-RJ4530M

SFP+ 10Gb/s Copper-T 30m RJ45

PRODUCT FEATURES

- Support 10Gbase-T/5Gbase-T/2.5Gbase-T/1000base-T
- Hot-pluggable SFP footprint
- Compact RJ-45 connector assembly
- Single +3.3V power supply
- 10 Gigabit Ethernet over Cat 6a cable
- Operating temperature: 0°C to +70°C
- RoHS compliant and lead-free

APPLICATIONS

- 10GBASE-T 10G Ethernet

PRODUCT DESCRIPTION

FIBRECROSS's SP10-RJ4530M SFP+ Copper-T 10Gbps transceiver is based on the SFP Multi Source Agreement (MSA). They are compatible with the 10Gbase-T / 5Gbase-T / 2.5Gbase-T / 1000base-T standards as specified in IEEE Std 802.3. SFP+-10GBASE-T uses the SFP's RX LOS (must be pulled up on host) pin for link indication. If pull up or open SFP's TX_DISABLE pin, PHY IC be reset.

General Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Data Rate	BR	1		10	Gbps
I ^{2}C Clock Rate		0		200,000	Hz

Notes:
1. Clock tolerance is +/- 50 ppm

Environmental Specifications

Automatic crossover detection is enabled. External crossover cable is not required

Parameter	Symbol	Min	Typ	Max	unit	Notes/Conditions
Operating Temperature	Top	0		65	°C	Case temperature
Storage Temperature	Tsto	-40		85	°C	Ambient temperature

Cable Length

Standard	Cable	Reach	Host Port
10Gbase-T	CAT6A	30m	XFI
5Gbase-T/2.5Gbase-t	CAT5E	50m	5GBase-R/2.5GBase-X
1000base-T	CAT5E	100m	1000base-FX

SFP to Host Connector Pin Out

Pin	Symbol	Name/Description	Ref.
1	VEET	Transmitter Ground (Common with Receiver Ground)	1
2	TFAULT	Transmitter Fault. Not supported.	
3	TDIS	Transmitter Disable. Laser output disabled on high or open.	2
4	MOD_DEF(2)	Module Definition 2. Data line for Serial ID.	3
5	MOD_DEF(1)	Module Definition 1. Clock line for Serial ID.	3
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	3
7	Rate Select	No connection required	
8	LOS	High indicates no linked. low indicates linked.	4
9	VEER	Receiver Ground (Common with Transmitter Ground)	1
10	VEER	Receiver Ground (Common with Transmitter Ground)	1
11	VEER	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATA out. AC Coupled	
13	RD+	Receiver Non-inverted DATA out. AC Coupled	
14	VEER	Receiver Ground (Common with Transmitter Ground)	1
15	VCCR	Receiver Power Supply	
16	VCCT	Transmitter Power Supply	

17	VEET	Transmitter Ground (Common with Receiver Ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	VEET	Transmitter Ground (Common with Receiver Ground)	1

Notes:

1. Circuit ground is connected to chassis ground
2. PHY disabled on T_{DIS} > 2.0V or open, enabled on T_{DIS} < 0.8V
3. Should be pulled up with 4.7k - 10k Ohms on host board to a voltage between 2.0 V and 3.6 V. MOD_DEF(0) pulls line low to indicate module is plugged in.
4. LVTTL compatible with a maximum voltage of 2.5V.

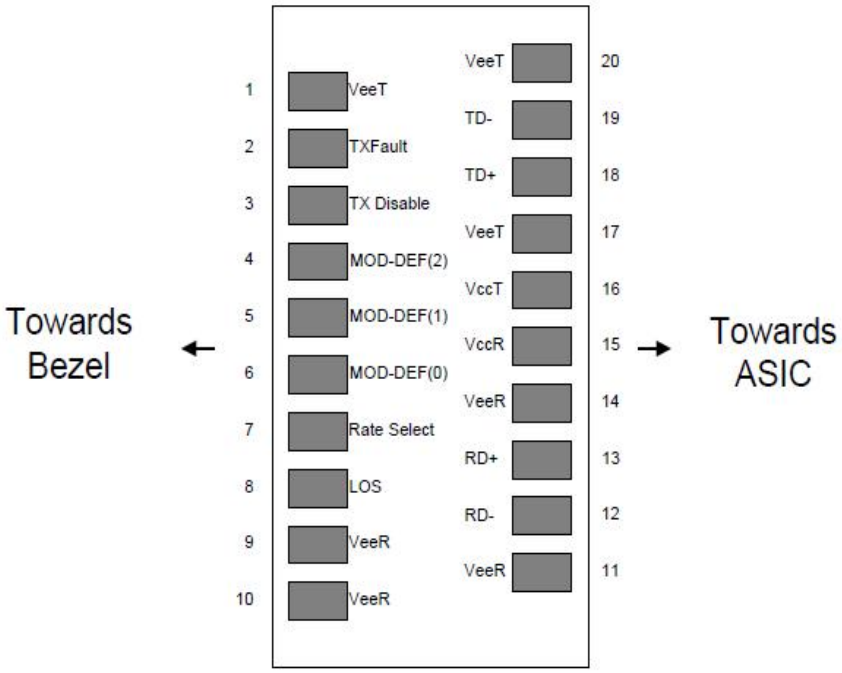


Figure 1. Diagram of host board connector block pin numbers and names

3.3V Volt Electrical Power Interface

The SFP+-10GBASE-T has an input voltage range of 3.3 V +/- 5%. The 4V maximum voltage is not allowed for continuous operation.

3.3 Volt Electrical Power Interface

Parameter	Symbol	Min	Typ	Max	unit	Notes/Conditions
Supply Current	Is		700	900	mA	3.0W max power over full range of voltage and temperature. See caution note below
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND
Maximum Voltage	Vmax			4	V	
Surge Current	Isurge		TBD		mA	Hot plug above steady state current. See caution note below

Notes: Power consumption and surge current are higher than the specified values in the SFP MSA

Low-Speed Signals

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to host Vcc

Low-Speed Signals, Electronic Characteristics					
Parameter	Symbol	Min	Max	unit	Notes/Conditions
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Output HIGH	VOH	host_Vcc -0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector
SFP Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector

High-Speed Electrical Interface

All high-speed signals are AC-coupled internally.

High-Speed Electrical Interface, Transmission Line-SFP						
Parameter	Symbol	Min	Typ	Max	unit	Notes/Conditions
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3
Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all frequencies between 1MHz and 125MHz
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all frequencies between 1MHz and 125MHz

High-Speed Electrical Interface, Host-SFP						
Parameter	Symbol	Min	Typ	Max	unit	Notes/Conditions

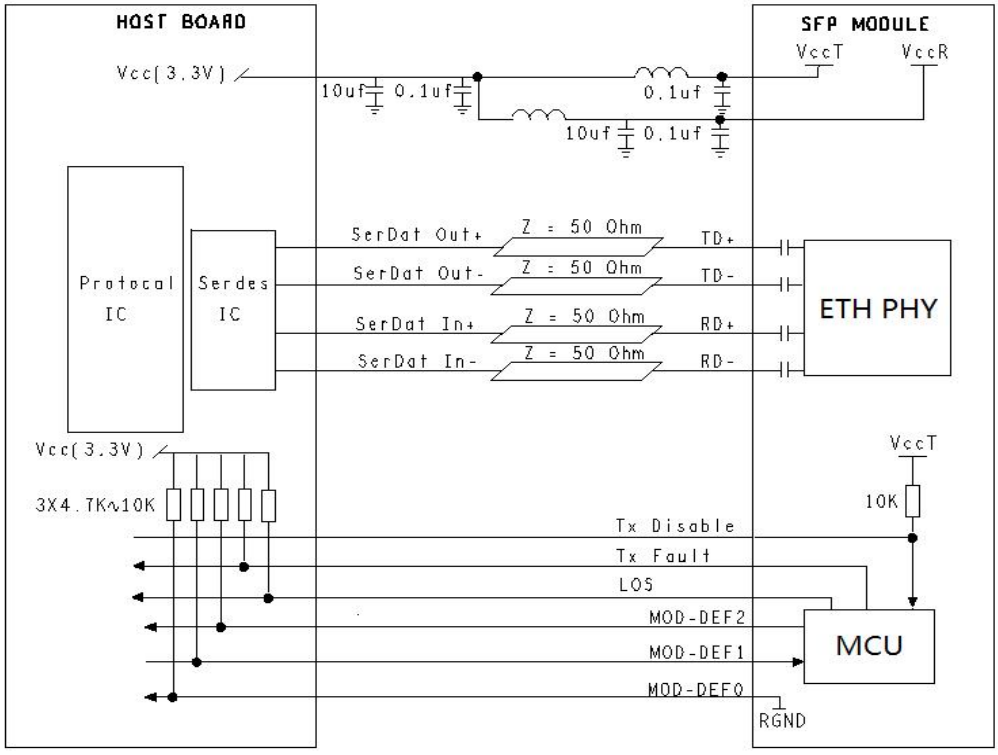
Single ended data input swing	Vinsing	250		1200	mV	Single ended
Single ended data output swing	Voutsing	350		800	mV	Single ended
Rise/Fall Time	T_r,T_f		175		psec	20%-80%
Tx Input Impedance	Zin		50		Ohm	Single ended
Rx Output Impedance	Zout		50		Ohm	Single ended

General Specifications

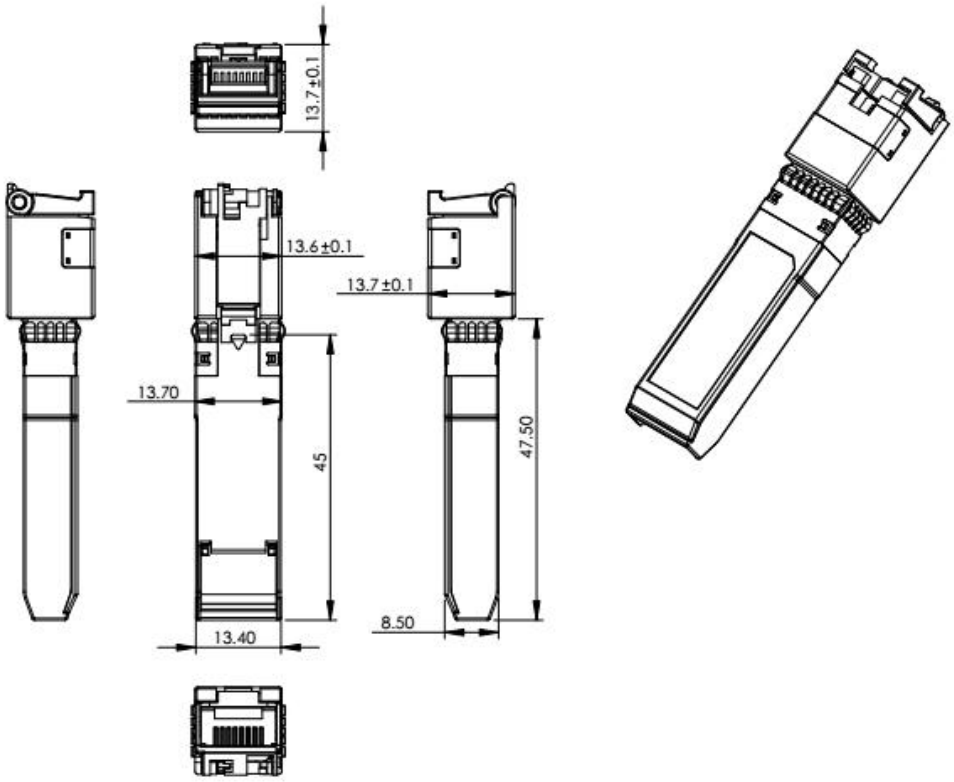
General						
Parameter	Symbol	Min	Typ	Max	unit	Notes/Conditions
Data Rate	BR	1		10	Gb/sec	IEEE 802.3 compatible. See Notes 1,2 below

Notes: Clock tolerance is +/- 50 ppm

Recommended Application Circuit



Mechanical Specifications (Unit: mm)



Regulatory Compliance

Feature	Reference	Performance
Electrostatic discharge（ESD）	IEC/EN 61000-4-2	Compatible with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN 55022 Class B (CISPR 22A)	Compatible with standards
Laser Eye Safety	IEC/EN 60825-1, 2	Class 1 laser product
ROHS	2002/95/EC	Compatible with standards
EMC	EN61000-3	Compatible with standards